



60V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
01	1.7Ω @ V _{GS} = 10V		510mA
Q1 60V	3Ω @ V _{GS} = 4.5V	393mA	
Q2	-60V	8Ω @ V _{GS} = -5V	-244mA

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface-Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

An automotive-compliant part is available under a separate datasheet (DMC62D3SVQ)

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- General-purpose interfacing switches
- Power-management functions
- Analog switches

Mechanical Data

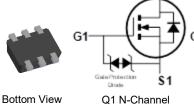
- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (Approximate)

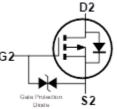




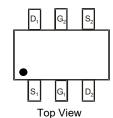
Top View







Q2 P-Channel



Internal Schematic

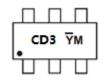
Ordering Information (Note 4)

Orderable Part Number	Dackage	Packing			
Orderable Part Number	Package	Qty.	Carrier		
DMC62D3SV-7	SOT563	3,000	Tape & Reel		
DMC62D3SV-13	SOT563	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



CD3 = Product Type Marking Code YM = Date Code Marking \overline{Y} = Year (ex: M = 2025)

M = Month (ex: 9 = September)

Date Code Key

Year	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035	2036
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Voltage		Vgss	±20	V	
Continuous Drain Current (Note 5) $V_{GS} = 10V$ Steady State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		lo	510 408	mA	
Maximum Body Diode Forward Current (Note 5)			Is	510	mA
Pulsed Drain Current (Note 5)	I _{DM}	1	Α		
Pulsed Source Current (Note 5)			Isм	1	Α

Maximum Ratings P-CHANNEL – Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	-60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = -5V$ Steady State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	-244 -195	mA	
Maximum Continuous Body Diode Forward Curre	ent (Note 6)		Is	-244	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)	I _{DM}	-1	Α	
Pulsed Source Current (10µs Pulse, Duty Cycle	= 1%)		I _{SM}	-1	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)		PD	0.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	241	°C/W
Total Power Dissipation (Note 5)	·	P _D	0.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	140	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Electrical Characteristics N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	V _{GS} = 0, I _D = 250µA
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μA	V _{DS} = 60V, V _{GS} = 0
Gate-Source Leakage	Igss	_	_	±10	μΑ	V _{GS} = ±20V, V _{DS} = 0
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	1.0	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	D	_	1.0	1.7	Ω	V _{GS} = 10V, I _D = 200mA
	R _{DS(ON)}	_	1.2	3	12	$V_{GS} = 4.5V, I_D = 200mA$
Diode Forward Voltage	VsD	-	0.85	1.4	V	V _{GS} = 0, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	41	_	pF	
Output Capacitance	Coss	_	4.5	_	pF	$V_{DS} = 30V, V_{GS} = 0$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.7	_	pF	1 - 1.001112
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	0.51	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	1	1.04	_	nC	V _{DS} = 15V, I _D = 200mA
Gate-Source Charge	Qgs	1	0.16	_	nC	VDS = 15V, ID = 20011IA
Gate-Drain Charge	Q_{gd}	1	0.18	_	nC	
Turn-On Delay Time	t _{D(ON)}	1	6.9	_	ns	
Turn-On Rise Time	t_R	1	5.8	_	ns	V _{DD} = 30V, V _{GS} = 10V
Turn-Off Delay Time	t _{D(OFF)}	1	37.8	_	ns	$R_g = 150\Omega$, $I_D = 200mA$
Turn-Off Fall Time	tF	-	14.3	_	ns	
Reverse-Recovery Time	t_{RR}		19	_	ns	$I_F = 1A$, di/dt = 100A/ μ s
Reverse-Recovery Charge	Qrr	_	9	_	nC	I _F = 1A, di/dt = 100A/μs

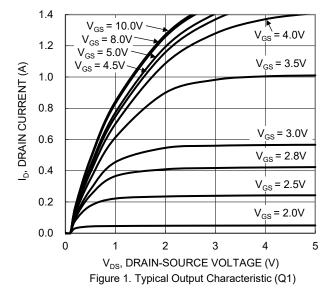
Electrical Characteristics P-CHANNEL – Q2 (@TA = +25°C, unless otherwise specified.)

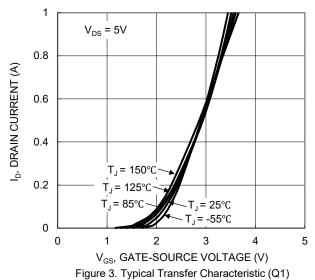
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)		•		•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	-60	_	_	V	V _{GS} = 0, I _D = -250μA	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1.0	μΑ	V _{DS} = -60V, V _{GS} = 0	
Gate-Source Leakage	Igss	_	_	±10	μΑ	V _{GS} = ±20V, V _{DS} = 0	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.8	_	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	Rds(on)	_	2	8	Ω	$V_{GS} = -5V, I_{D} = -100mA$	
Diode Forward Voltage	VsD	_	-0.8	-1.5	V	V _{GS} = 0, I _S = -100mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	42	_		V _{DS} = -30V, V _{GS} = 0 f = 1.0MHz	
Output Capacitance	Coss	_	10	_	pF		
Reverse Transfer Capacitance	Crss	_	6	_			
Gate Resistance	Rg	_	225	_	Ω	$V_{DS} = 0$, $V_{GS} = 0$, $f = 1MHz$	
Total Gate Charge	Qg	_	0.6	_		5)/)/ 00)/	
Gate-Source Charge	Qgs	_	0.1	_	nC	$V_{GS} = -5V, V_{DS} = -30V$ $I_{D} = -100mA$	
Gate-Drain Charge	Qgd	_	0.2	_		ID = -100IIIA	
Turn-On Delay Time	t _{D(ON)}	_	11	_			
Turn-On Rise Time	t _R		16		no	V _{GS} = -5V, V _{DS} = -30V	
Turn-Off Delay Time	t _{D(OFF)}	_	30	_	ns	$R_g = 50\Omega$, $I_D = -100$ mA	
Turn-Off Fall Time	tF	_	30	_			

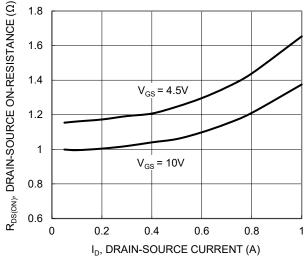
Notes:

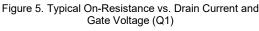
^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

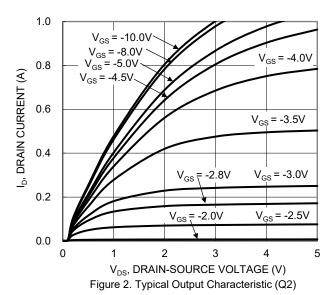


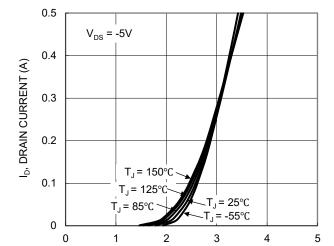












V_{GS}, GATE-SOURCE VOLTAGE (V)
Figure 4. Typical Transfer Characteristic (Q2)

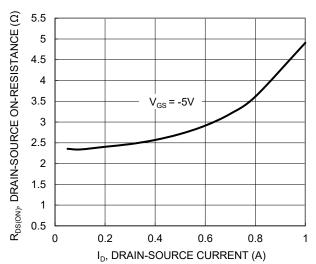


Figure 6. Typical On-Resistance vs. Drain Current and Gate Voltage (Q2)



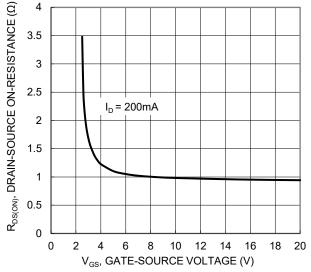


Figure 7. Typical Transfer Characteristic (Q1)

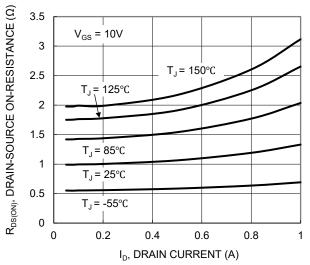


Figure 9. Typical On-Resistance vs. Drain Current and Junction Temperature (Q1)

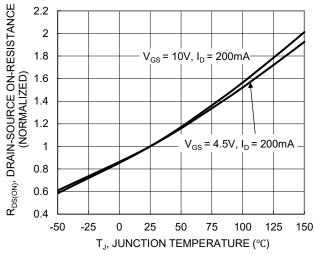


Figure 11. On-Resistance Variation with Junction Temperature (Q1)

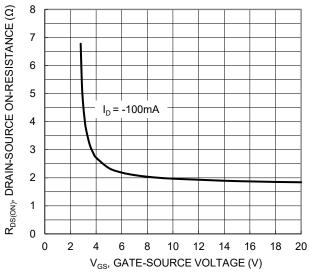


Figure 8. Typical Transfer Characteristic (Q2)

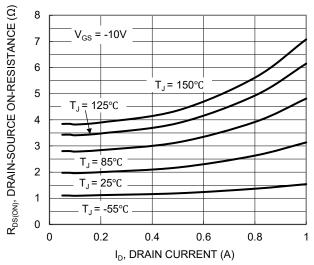


Figure 10. Typical On-Resistance vs. Drain Current and Junction Temperature (Q2)

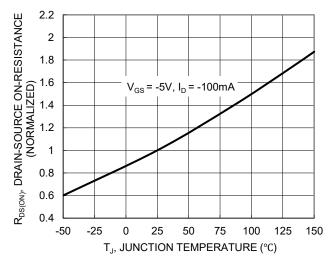


Figure 12. On-Resistance Variation with Junction Temperature (Q2)



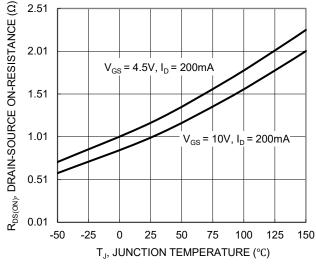


Figure 13. On-Resistance Variation with Junction Temperature (Q1)

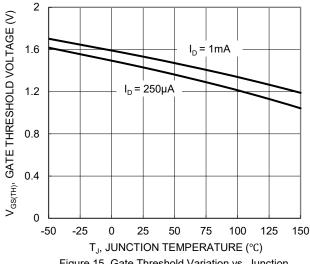


Figure 15. Gate Threshold Variation vs. Junction Temperature (Q1)

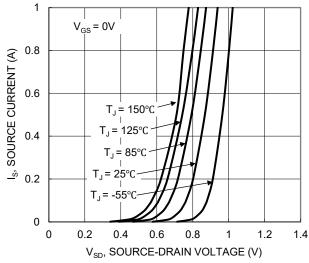


Figure 17. Diode Forward Voltage vs. Current (Q1)

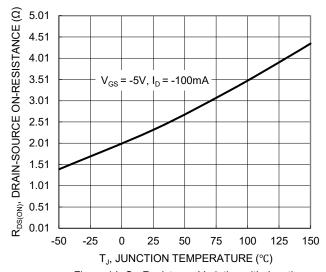


Figure 14. On-Resistance Variation with Junction Temperature (Q2)

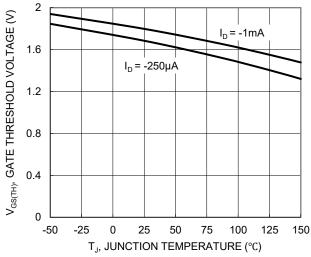


Figure 16. Gate Threshold Variation vs. Junction Temperature (Q2)

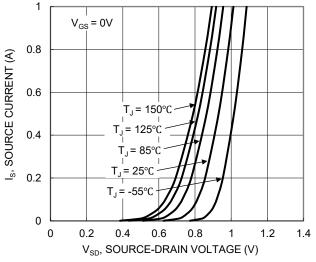
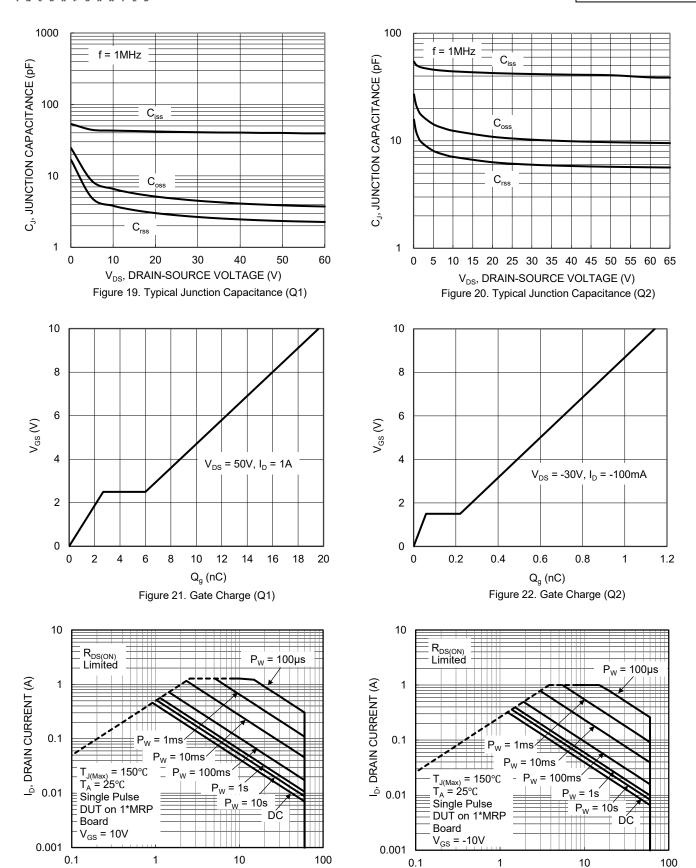


Figure 18. Diode Forward Voltage vs. Current (Q2)





V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 23. SOA, Safe Operation Area (Q1)

V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 24. SOA, Safe Operation Area (Q2)



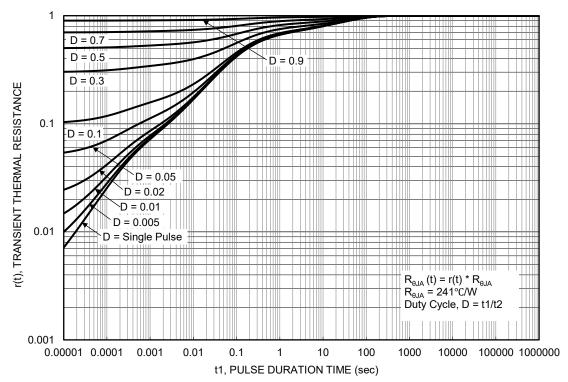


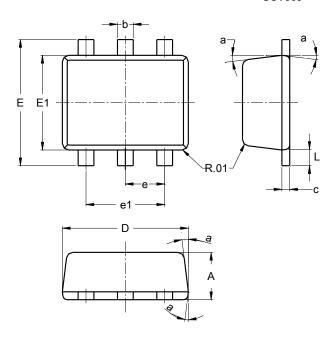
Figure 25. Transient Thermal Resistance (Q1/Q2)



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563

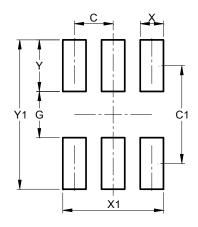


	SO.	T563				
Dim	Min	Max	Тур			
Α	0.55	0.60	-			
b	0.15	0.30	0.20			
С	0.10	0.18	0.11			
D	1.50 1.70		1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.10 1.25				
е	е		0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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